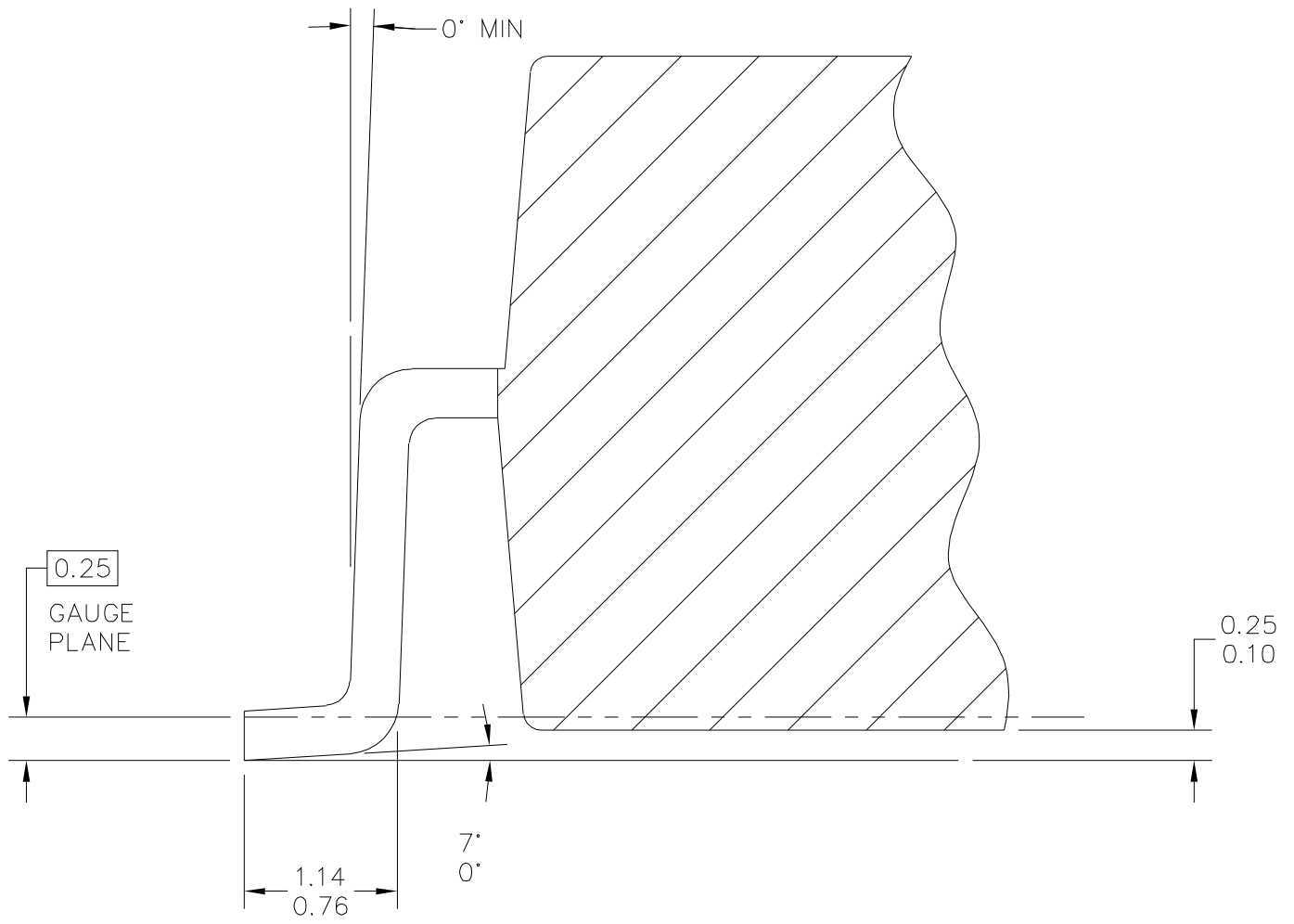


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TITLE: 20LD SOIC WIDE BODY PMCM CAVITY UP WITH LARGE METAL CAP HOLE	DOCUMENT NO: 98ASA10830D	REV: A
	STANDARD: NON-JEDEC	
	SOT1692-2	16 MAR 2016



SECTION B-B

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	STANDARD: NON-JEDEC		
	SOT1692-2	16 MAR 2016	



NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS.

2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

3. THIS DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15MM PER SIDE.

4. THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. PROTRUSIONS SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 0.75MM.

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